

IRF130 JANTX2N6756 JANTXV2N6756

# REPETITIVE AVALANCHE AND dv/dt RATED HEXFET®TRANSISTORS THRU-HOLE (TO-204AA)

100V, N-CHANNEL REF: MIL-PRF-19500/542

**Product Summary** 

Part Number	BV <sub>DSS</sub>	RDS(on)	I <sub>D</sub>
IRF130	100V	0.18Ω	14A



## Description

HEXFET® MOSFET technology is the key to IR Hirel advanced line of power MOSFET transistors. The efficient geometry and unique processing of this latest "State of the Art" design achieves: very low on-state resistance combined with high trans conductance; superior reverse energy and diode recovery dv/dt capability.

The HEXFET transistors also feature all of the well established advantages of MOSFETs such as voltage control, very fast switching and temperature stability of the electrical parameters. They are well suited for applications such as switching power supplies, motor controls, inverters, choppers, audio amplifiers and high energy pulse circuits.

#### **Features**

- Repetitive Avalanche Ratings
- Dynamic dv/dt Rating
- · Hermetically Sealed
- Simple Drive Requirements
- ESD Rating: Class 1C per MIL-STD-750, Method 1020

### **Absolute Maximum Ratings**

Symbol	Parameter	Value	Units	
I <sub>D1</sub> @ V <sub>GS</sub> = 10V, T <sub>C</sub> = 25°C	Continuous Drain Current	14		
I <sub>D2</sub> @ V <sub>GS</sub> = 10V, T <sub>C</sub> = 100°C	Continuous Drain Current	9.0	Α	
I <sub>DM</sub> @T <sub>C</sub> = 25°C	Pulsed Drain Current ①	56		
P <sub>D</sub> @T <sub>C</sub> = 25°C	Maximum Power Dissipation	75	W	
	Linear Derating Factor	0.6	W/°C	
$V_{GS}$	Gate-to-Source Voltage	± 20	V	
E <sub>AS</sub>	Single Pulse Avalanche Energy ②	75	mJ	
I <sub>AR</sub>	Avalanche Current ①	14	Α	
E <sub>AR</sub>	Repetitive Avalanche Energy ①	7.5	mJ	
dv/dt	Peak Diode Recovery 3	5.5	V/ns	
T <sub>J</sub>	Operating Junction and	-55 to + 150		
T <sub>STG</sub>	Storage Temperature Range	-95 to + 150	°C	
	Lead Temperature	300 (0.063 in. (1.6mm) from case for 10s)		
	Weight	11.5 (Typical)	g	

For footnotes refer to the page 2.



# Electrical Characteristics @ Tj = 25°C (Unless Otherwise Specified)

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
BV <sub>DSS</sub>	Drain-to-Source Breakdown Voltage	100			V	$V_{GS} = 0V, I_{D} = 1.0mA$
$\Delta BV_{DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient		0.13		V/°C	Reference to 25°C, I <sub>D</sub> = 1.0mA
R <sub>DS(on)</sub>	Static Drain-to-Source On-Resistance			0.18	Ω	V <sub>GS</sub> = 10V, I <sub>D2</sub> = 9.0A ④
				0.21		V <sub>GS</sub> = 10V, I <sub>D1</sub> = 14A ④
$V_{GS(th)}$	Gate Threshold Voltage	2.0		4.0	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
I <sub>DSS</sub>	Zara Cata Valta da Duais Comunant			25		$V_{DS} = 80V, V_{GS} = 0V$
	Zero Gate Voltage Drain Current			250	μA	$V_{DS} = 80V, V_{GS} = 0V, T_{J} = 125^{\circ}C$
$I_{GSS}$	Gate-to-Source Leakage Forward			100	nA	V <sub>GS</sub> = 20V
	Gate-to-Source Leakage Reverse			-100	IIA	V <sub>GS</sub> = -20V
$Q_G$	Total Gate Charge	12		35		I <sub>D1</sub> = 14A
$Q_{GS}$	Gate-to-Source Charge	2.5		10	nC	V <sub>DS</sub> = 50V
$Q_{GD}$	Gate-to-Drain ('Miller') Charge	5.0		15		V <sub>GS</sub> = 10V
$t_{d(on)}$	Turn-On Delay Time			35		$V_{DD} = 50V$
tr	Rise Time			80	no	I <sub>D1</sub> = 14A
$t_{d(off)}$	Turn-Off Delay Time			60	ns	$R_G = 7.5\Omega$
$t_f$	Fall Time			45		V <sub>GS</sub> = 10V
Ls +L <sub>D</sub>	Total Inductance		6.1		nЦ	Measured from Drain lead (6mm / 0.25 in from package) to Source lead (6mm/ 0.25 in from package)
C <sub>iss</sub>	Input Capacitance		650			V <sub>GS</sub> = 0V
C <sub>oss</sub>	Output Capacitance		250		pF	V <sub>DS</sub> = 25V
C <sub>rss</sub>	Reverse Transfer Capacitance		44			f = 1.0MHz

# Source-Drain Diode Ratings and Characteristics

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
Is	Continuous Source Current (Body Diode)			14	۸	
I <sub>SM</sub>	Pulsed Source Current (Body Diode) ①			56	Α	
$V_{SD}$	Diode Forward Voltage			1.5	V	$T_J = 25^{\circ}C, I_S = 14A, V_{GS} = 0V$
t <sub>rr</sub>	Reverse Recovery Time			300	ns	$T_J = 25^{\circ}C, I_F = 14A, V_{DD} \le 30V$
Q <sub>rr</sub>	Reverse Recovery Charge			3.0	μC	di/dt = 100A/µs ④
t <sub>on</sub>	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by L <sub>S</sub> +L <sub>D</sub> )				

## **Thermal Resistance**

Symbo	ol Parameter	Min.	Тур.	Max.	Units	
$R_{ heta JC}$	Junction-to-Case			1.67	°C/\\/	
$R_{ heta JA}$	Junction-to-Ambient (Typical socket mount	)		30	°C/W	

#### Footnotes:

- ① Repetitive Rating; Pulse width limited by maximum junction temperature.
- $^{\circ}$  V<sub>DD</sub> = 50V, starting T<sub>J</sub> = 25°C, L= 0.77mH, Peak I<sub>L</sub> = 14A, V<sub>GS</sub> = 10V.

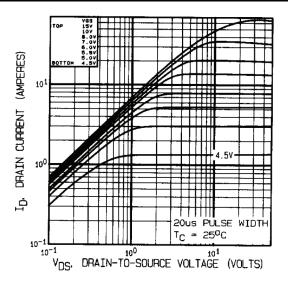


Fig 1. Typical Output Characteristics

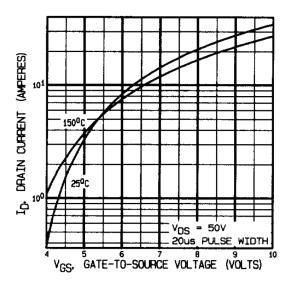


Fig 3. Typical Transfer Characteristics

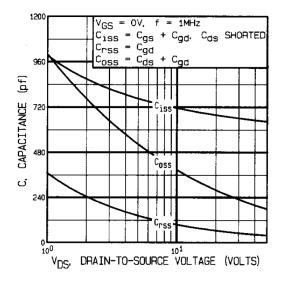


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

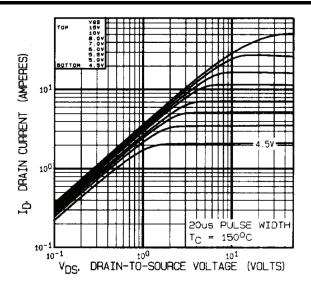


Fig 2. Typical Output Characteristics

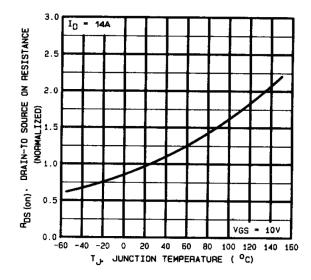


Fig 4. Normalized On-Resistance Vs. Temperature

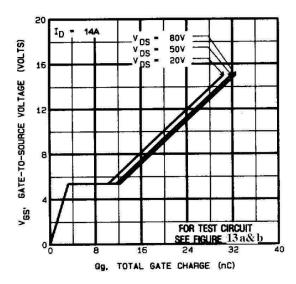


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

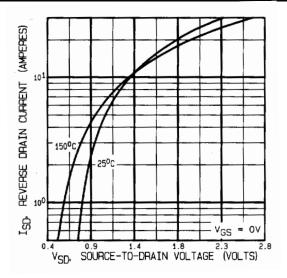


Fig 7. Typical Source-Drain Diode Forward Voltage

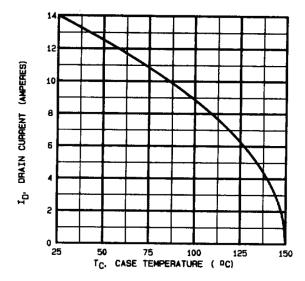


Fig 9. Maximum Drain Current Vs. Case Temperature

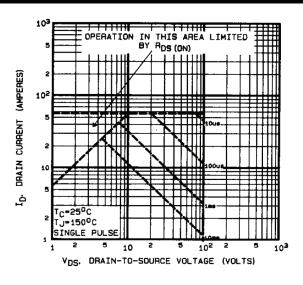
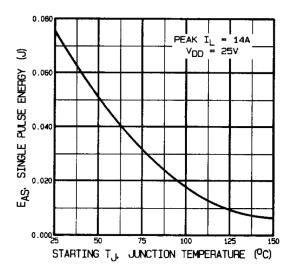


Fig 8. Maximum Safe Operating Area



**Fig 10.** Maximum Avalanche Energy Vs. Drain Current

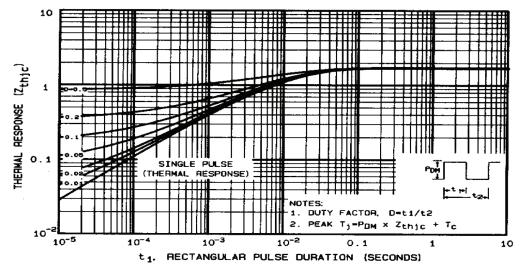


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

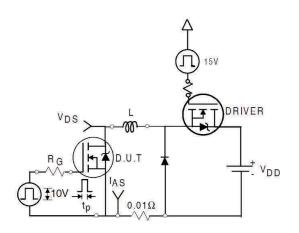


Fig 12a. Unclamped Inductive Test Circuit

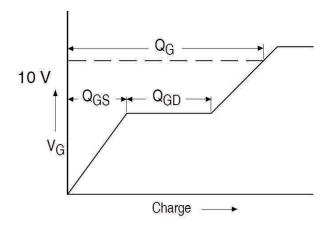


Fig 13a. Gate Charge Waveform

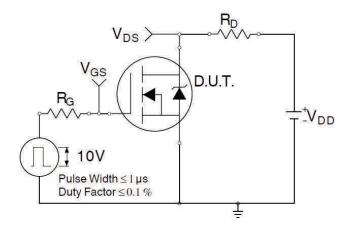


Fig 14a. Switching Time Test Circuit

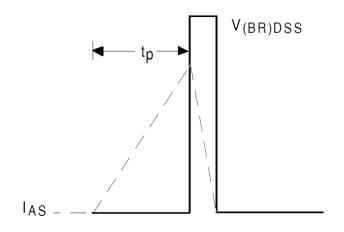


Fig 12b. Unclamped Inductive Waveforms

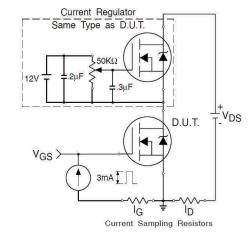


Fig 13b. Gate Charge Test Circuit

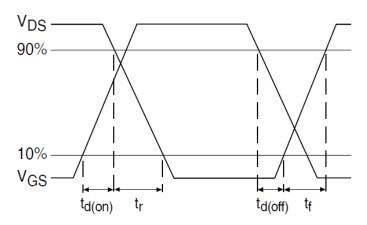
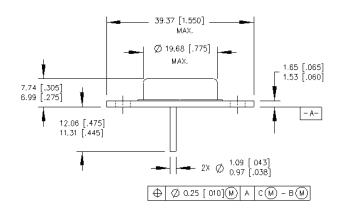
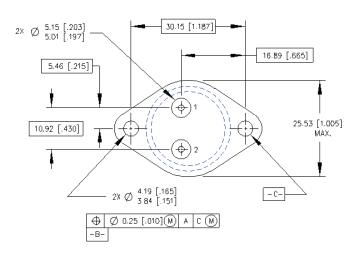


Fig 14b. Switching Time Waveforms



## Case Outline and Dimensions - TO-204AA (Modified TO-3)





#### PIN ASSIGNMENTS

**HEXFET SCHOTTKY** <u>IGBT</u> 1 - SOURCE 1 - ANODE 1 1 - GATE 2 - GATE 3 - DRAIN (CASE) 2 - EMITTER 3 - COLLECTOR (CASE) 2 - ANODE 2 3 - COMMON CATHOD (CASE)

#### NOTES:

- 1. DIMENSIONING & TOLERANCING PER ANSI Y14.5M 1982.
- 2. CONTROLLING DIMENSION: INCH.
- 3. DIMENSIONS ARE SHOWN IN MILIMETERS [ INCHES]
  4. OUTLINE CONFORMS TO JEDEC OUTLINE TO -204-AA



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